

Surface Mount Schottky Barrier Rectifier
Reverse Voltage - 20 to 200 V
Forward Current - 5 A
FEATURES

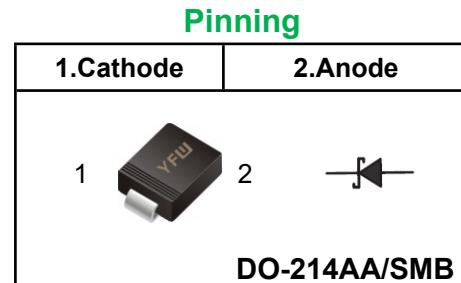
- ◆ Metal silicon junction, majority carrier conduction
- ◆ For surface mounted applications
- ◆ Low power loss, high efficiency
- ◆ High forward surge current capability
- ◆ For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- ◆ Case: DO-214AA/SMB
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 0.095g / 0.003oz

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 ° ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %


Marking Code

SS52B	YFW SS52
SS54B	YFW SS54
SS56B	YFW SS56
SS58B	YFW SS58
SS510B	YFW SS510
SS512B	YFW SS512
SS515B	YFW SS515
SS520B	YFW SS520

Parameter	Symbols	SS52B	SS54B	SS56B	SS58B	SS510B	SS512B	SS515B	SS520B	Units										
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V										
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V										
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V										
Maximum Average Forward Rectified Current	I_{F(AV)}	5.0								A										
Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed On Rated Load (JEDEC method)	I_{FSM}	150								A										
Maximum Instantaneous Forward Voltage at 5 A	V_F	0.55		0.70		0.85		0.90		V										
Maximum Instantaneous Reverse Current $T_A = 25^\circ C$ at Rated DC Reverse Voltage $T_A = 100^\circ C$	I_R	1.0 50		0.3 25						mA										
Typical Junction Capacitance ⁽¹⁾	C_j	500		300						pF										
Typical Thermal Resistance ⁽²⁾	R_{θJA}	50								°C/W										
Operating Junction Temperature Range	T_j	-55 ~ +150								°C										
Storage Temperature Range	T_{stg}	-55 ~ +150								°C										

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

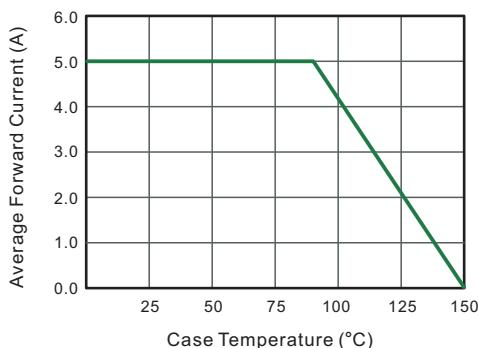


Fig.2 Typical Reverse Characteristics

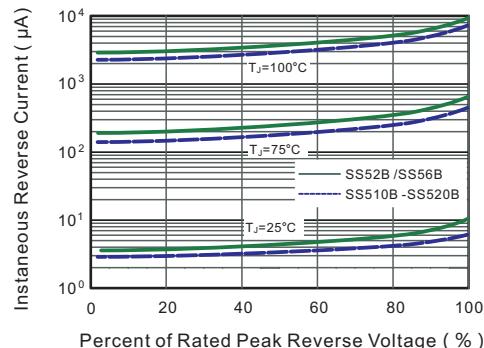


Fig.3 Typical Forward Characteristic

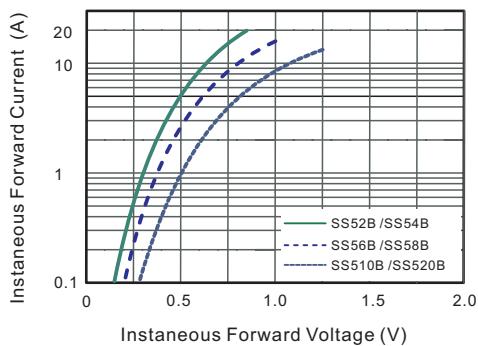


Fig.4 Typical Junction Capacitance

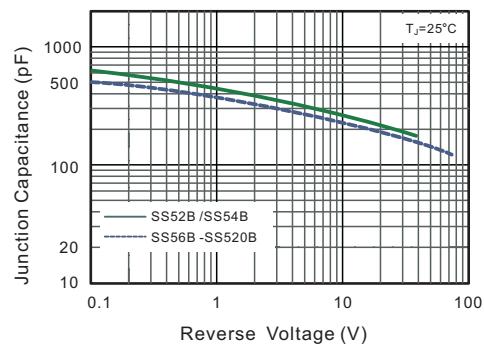


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

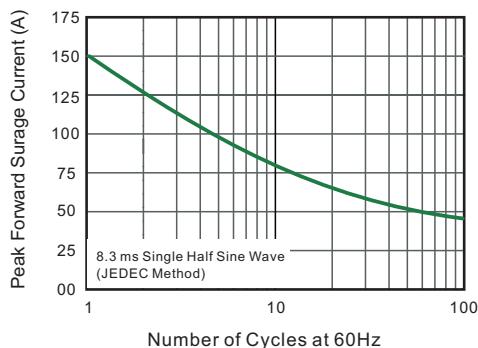
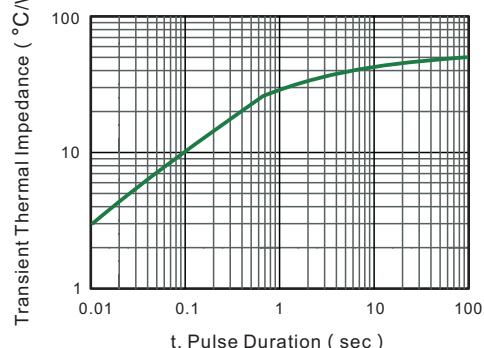
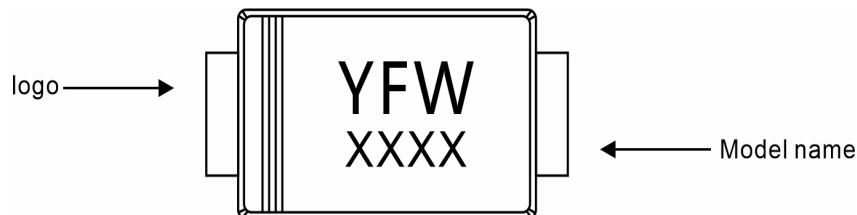


Fig.6- Typical Transient Thermal Impedance

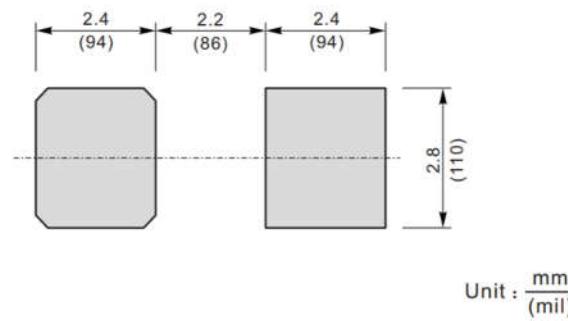


Marking Diagram

Ordering information

Package	Packing Description	Packing Quantity			
DO-214AA SMB	Tape/Reel, 13" reel	3000PCS/Reel 30000PCS/Carton			

Package Dimensions
DO-214AA SMB

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	2.13	2.44	84	96
E	4.06	4.70	160	185
D	3.3	3.94	130	155
E ₁	5.08	5.59	200	220
A ₁	0.05	0.20	2.0	7.9
L	0.8	1.5	32	59
C	0.152	0.305	6	12
b	1.9	2.2	75	87

The recommended mounting pad size


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